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NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE30P50G uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications.

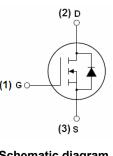
General Features

- V_{DS} =-30V,I_D =-50A $R_{DS(ON)}$ < 5.5m Ω @ V_{GS} =-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

Battery and loading switching

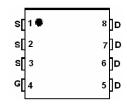
100% UIS TESTED!



Schematic diagram



Marking and pin assignment



DFN 5x6 EP top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30P50G	NCE30P50G	DFN 5x6 EP	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-30	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	-50	А	
Pulsed Drain Current	I _{DM}	-70	А	
Maximum Power Dissipation	P _D	65	W	
Derating factor		0. 52	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	300	mJ	
Operating Junction and Storage Temperature Range	T_{J},T_{STG}	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2) R _{0JC} 1.93 °C/W
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Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1	-1.5	-2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-10A	-	5	7	mΩ
Forward Transconductance	g Fs	V _{DS} =-10V,I _D =-15A	-	20	-	S
Dynamic Characteristics (Note4)			•			•
Input Capacitance	C _{lss}	\/ 45\/\/ 0\/	-	3590	-	PF
Output Capacitance	Coss	V_{DS} =-15V, V_{GS} =0V, F=1.0MHz	-	695	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0WHZ	-	665	-	PF
Switching Characteristics (Note 4)	<u> </u>		•			
Turn-on Delay Time	t _{d(on)}		-	13	-	nS
Turn-on Rise Time	t _r	V _{DD} =-15V,I _D =-10A	-	12	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω	-	50	-	nS
Turn-Off Fall Time	t _f		-	14	-	nS
Total Gate Charge	Qg	\/ - 45\/ - 400	-	84	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-10A, V _{GS} =-10V	-	11.7	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} 10V	-	25	-	nC
Drain-Source Diode Characteristics	<u>.</u>		•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =-10A	-	-0.85	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-50	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = -10A	-	-	45	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs(Note3)	-	-	43	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

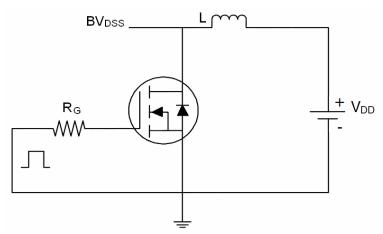
Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=-15V,V_G=-10V,L=0.5mH,Rg=25 Ω

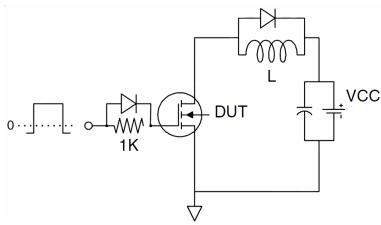
NCE30P50G

Test Circuit

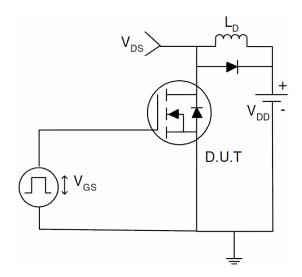
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit

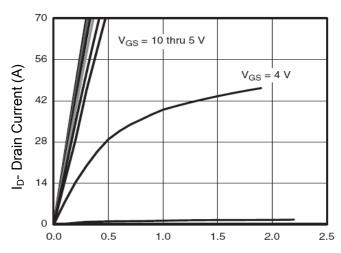


3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

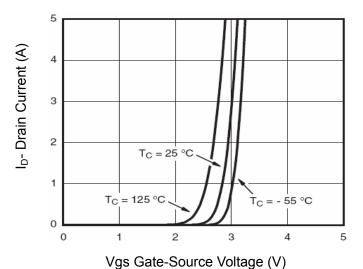
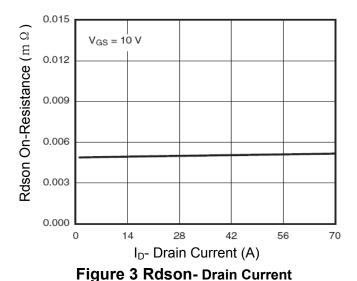


Figure 2 Transfer Characteristics



Normalized On-Resistance On-Re

Figure 4 Rdson-Junction Temperature

T_J-Junction Temperature(°C)

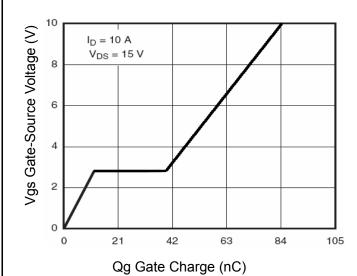


Figure 5 Gate Charge

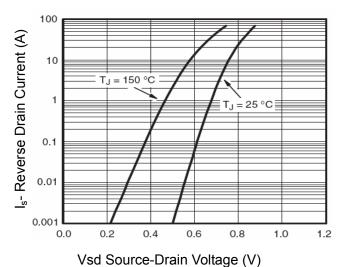


Figure 6 Source- Drain Diode Forward



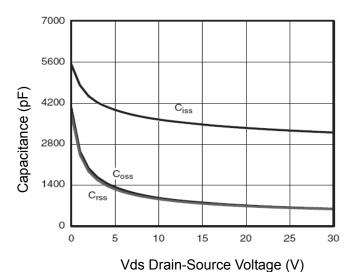
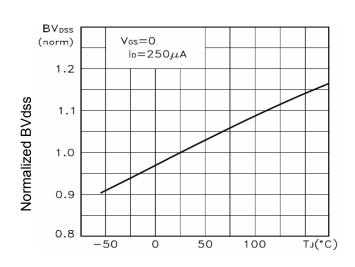


Figure 7 Capacitance vs Vds



 T_J -Junction Temperature (°C) Figure 9 BV_{DSS} vs Junction Temperature

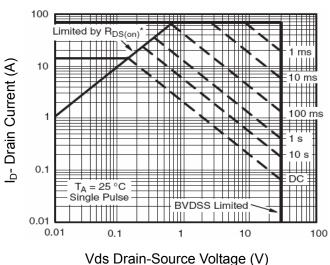


Figure 8 Safe Operation Area

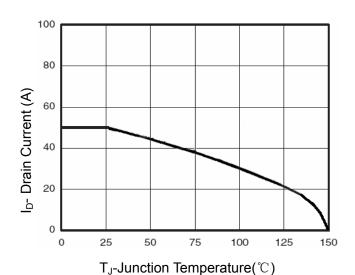
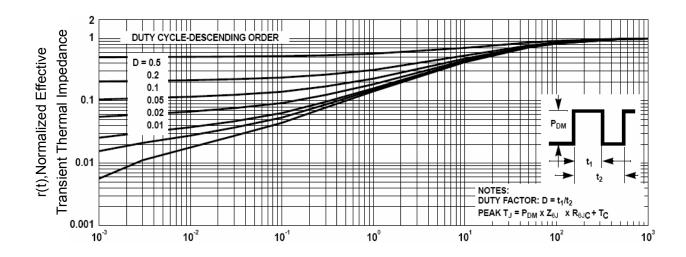


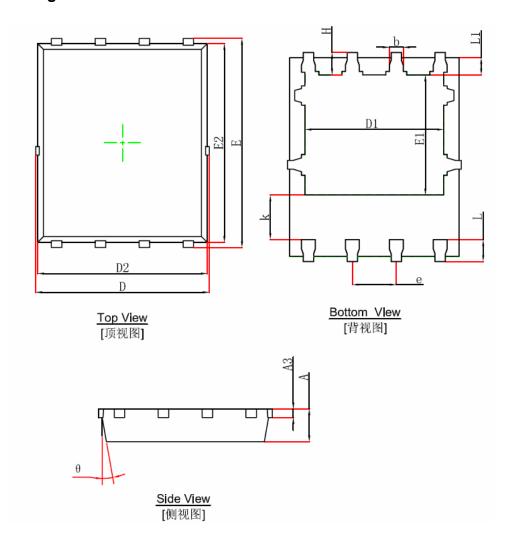
Figure 10 ID Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254REF.		0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270TYP.		0.050TYP.		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	

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